

# dsPICDEM™ MC1 Motor Control Development System

## Summary

The Motor Control Development System provides the application developer with three main components for quick prototyping and validation of BLDC, PMAC and ACIM applications. The three main components are: dsPICDEM MC1 Motor Control Development Board, dsPICDEM MC1L 3-Phase Low Voltage Power Module and dsPICDEM MC1H 3-Phase High Voltage Power Module.

The dsPICDEM MC1 Motor Control Development Board contains the dsPIC30F6010 but supports all dsPIC® MCU motor control variances, various peripheral interfaces and a custom interface header system, which allows different motor power modules to be connected to the PCB. The control board also has connectors for mechanical position sensors, such as incremental rotary encoders and hall effect sensors, and a breadboard area for custom circuits. The main control board receives its power from a standard plug-in transformer.

The dsPICDEM MC1L 3-Phase Low Voltage Power Module is optimized for 3-phase motor applications that require a DC bus voltage less than 50 volts and can deliver up to 400W power output. The 3-phase low voltage power module is intended to power BLDC and PMAC motors.

The dsPICDEM MC1H 3-Phase High Voltage Power Module is optimized for 3-phase motor applications that require DC bus voltages up to 400 volts and can deliver up to 1 kW power output. The high voltage module has an active power factor correction circuit that is controlled by the dsPIC30F device. This power module is intended for AC induction motor and power inverter applications that operate directly from the AC line voltage.

Two motors are available that are compatible with the development system.



## Features

A feature of the dsPICDEM MC1 Motor Control Development Board is:

- dsPIC30F6010 Motor Control MCU Based Board

The optional power modules provide:

- Heatsink for Ambient Cooling of Power Sections
- Full Automatic Protection of Power Circuits
- Electrical Isolation from Power Circuits
- Many Options for Motor Feedback Signals

## Package Contents (Motor Control Development Board)

- dsPICDEM MC1 Motor Control Development Board with Pre-programmed dsPIC30F Device
- RS-232 Cable
- Power Supply
- Example Software and Documentation on CD

## Package Contents (Power Modules)

- High Voltage or Low Voltage Power Module
- Example Software and Documentation on CD

## Host System Requirements

- PC-compatible system with an Intel Pentium® class or higher processor, or equivalent
- A minimum of 16 MB RAM
- A minimum of 40 MB available hard drive space
- CD ROM drive
- Microsoft Windows® 98, Windows NT® 4.0, Windows 2000 or Windows XP

## Part Numbers and Ordering Information:

dsPICDEM™ MC1 Motor Control Development System		
Part Number	Description	Availability
DM300020	dsPICDEM MC1 Motor Control Development Board (Supports dsPIC30F6010)	Now
DM300021	dsPICDEM MC1H 3-Phase High Voltage Power Module	Now
DM300022	dsPICDEM MC1L 3-Phase Low Voltage Power Module	Now
AC300020	3-Phase BLDC Low Voltage Motor (24V)	Now
AC300021	3-Phase ACIM High Voltage Motor (208/460V)	Now

## Development Tools from Microchip

MPLAB® IDE	Integrated Development Environment (IDE)
MPASM™ Assembler	Universal PICmicro macro-assembler
MPLINK™ Linker/MPLIB™ Librarian	Linker/Librarian
MPLAB C17	C compiler for PIC17CXXX MCUs
MPLAB C18	C compiler for PIC18CXXX MCUs
MPLAB SIM Simulator	Software Simulator
MPLAB ICD 2	In-Circuit Debugger
MPLAB ICE 2000	Full-featured modular in-circuit emulator
PICSTART® Plus Programmer	Entry-level development kit with programmer
PRO MATE® II Device Programmer	Full-featured, modular device programmer
KEELoo® Evaluation Kit	Encoder/Decoder evaluator
KEELoo Transponder Evaluation Kit	Transmitter/Transponder evaluator
microID™ Developer's Kit	125 kHz and 13.56 MHz RFID development tools
MCP2510 CAN Developer's Kit	MCP2510 CAN evaluation/development tool

Americas	Asia/Pacific	Europe
Atlanta (770) 640-0034	Australia	61-2-9868-6733
Boston (978) 692-3848	China – Beijing	86-10-85282100
Chicago (630) 285-0071	China – Chengdu	86-28-86766200
Dallas (972) 818-7423	China – Fuzhou	86-591-7503506
Detroit (248) 538-2250	China – Hong Kong SAR	852-2401-1200
Kokomo (765) 864-8360	China – Qingdao	86-532-5027355
Los Angeles (949) 263-1888	China – Shanghai	86-21-6275-5700
Phoenix (480) 792-7966	China – Shenzhen	86-755-82901380
San Jose (408) 436-7950	China – Shunde	86-765-8395507
Toronto (905) 673-0699	India	91-80-2290061
	Japan	81-45-471- 6166
	Korea	82-2-554-7200
	Singapore	65-6334-8870
	Taiwan	886-2-2717-7175
	Taiwan – Kaohsiung	886-7-536-4818

As of 9/1/03

Microchip Technology Inc. • 2355 W. Chandler Blvd. • Chandler, AZ 85224-6199 USA • (480) 792-7200 • FAX (480) 792-7277

The Microchip name and logo, the Microchip logo, dsPIC, KeeLoq, MPLAB, PIC, PICmicro, PICSTART, PRO MATE and PowerSmart are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries. FilterLab, microID, MXDEV, MXLAB, PICMASTER, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A. Accuron, Application Maestro, dsPICDEM, dsPICDEM.net, ECAN, ECONOMONITOR, FanSense, FlexROM, fuzzyLAB, In-Circuit Serial Programming, ICSP, ICEPIC, microPort, Migratable Memory, MPASM, MPLIB, MPLINK, MPSIM, PICC, PICkit, PICDEM, PICDEM.net, PowerCal, PowerInfo, PowerMate, PowerTool, rfLAB, rfPIC, Select Mode, SmartSensor, SmartShunt, SmartTel and Total Endurance are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries. Serialized Quick Turn Programming (SQTP) is a service mark of Microchip Technology Incorporated in the U.S.A. All other trademarks mentioned herein are property of their respective companies.

© 2003, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved. 10/03

DS51429A

